## **BGA Heat Sink - High Performance** maxiFLOW/maxiGRIP-Low Profile





ATS Part#: ATS-51290R-C1-R0

Description: 29.00 x 29.00 x 19.50 mm BGA Heat Sink - High

Performance maxiFLOW/maxiGRIP-Low Profile

Heat Sink Type: maxiFLOW Heat Sink Attachment: maxiGRIP

Equivalent Part Number: ATS-51290R-C2-R0 Discontinued

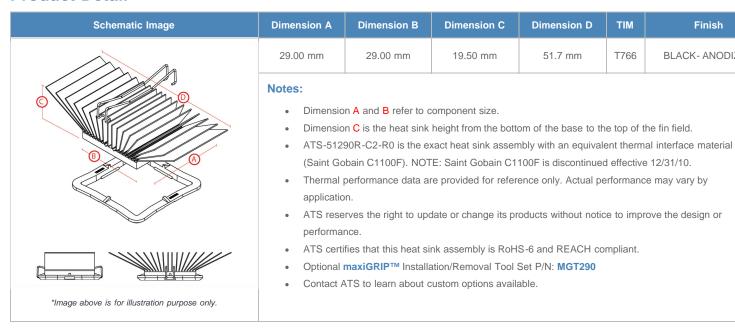
## **Features & Benefits**

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock and Unpackaged Drop Testing standards
- Comes preassembled with high performance, phase changing, thermal interface material
- Designed for low profile components from 1.5 to 2.99mm

## Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	3.4 °C/W	2.8 °C/W	2.4 °C/W	2.2 °C/W	2 °C/W	1.9 °C/W	1.8 °C/W
	Ducted Flow	2.7	N/A	N/A	N/A	N/A	N/A	N/A

## **Product Detail**



For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.



**Finish** 

**BLACK- ANODIZED** 

<sup>\*</sup>Image above is for illustration purpose only.